Docket No.: 085027-0055 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Customer Number: 89518

Mou-Shiung Lin, et al.

: Confirmation Number: 5504

Application No.: 10/054,001

Group Art Unit: 2827

Patent No.: 6,673,698

Issued: January 6, 2004

For: THIN FILM SEMICONDUCTOR PACKAGE UTILIZING A GLASS SUBSTRATE WITH COMOSITE POLYMER/METAL INTERCONNECT LAYERS

TRANSMITTAL OF POWER OF ATTORNEY

Commissioner for Patents

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I hereby certify that this correspondence is being electronically-transmitted to the United States Patent and Trademark Office on March 2.3, 2011.

Alexandria, VA 22313-1450 United States Patent

Sir:

Transmitted herewith is a Fee Address Indication Form, Power Of Attorney to Prosecute Applications Before the USPTO, together with a Statement Under 37 CFR 3.73(b), which revokes all previous powers of attorney given in the above-identified application and associates the application with Customer Number 89518.

Respectfully submitted,

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